HFG 52

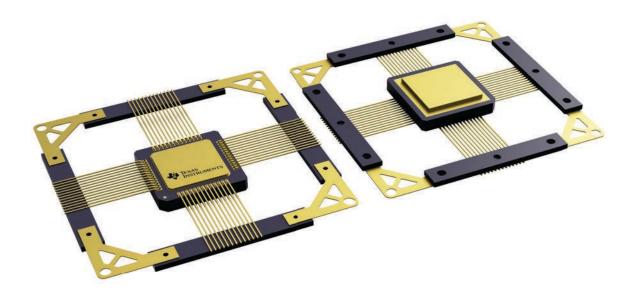
GENERIC PACKAGE VIEW

CFP - 3.68 mm max height

19.065 x 19.065, 0.635 mm pitch

CERAMIC FLATPACK

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





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